



Image

1763

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of

Applicants : John T. Davlin et al.

Serial No. : 09/651,498

Filed : August 30, 2000

Title : TEMPERATURE CONTROL ELEMENTS, SPINDLE ASSEMBLY AND
WAFER PROCESSING ASSEMBLY INCORPORATING SAME

Docket : MIO 0071 PA/40509.127

Examiner : R. Kackar

Art Unit : 1763

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on February 24, 2004.

Commissioner for Patents
PO Box 1450
Alexandria, Virginia 22313-1450

John D. Reed

Reg. No. 46,506

Sir:

AMENDMENT UNDER 37 C.F.R. 1.111

This paper is being filed in response to the Office Action dated February 10, 2004, having a reply due date of May 10, 2004. Reconsideration is respectfully requested in light of the remarks below.

Remarks begin on page 2 of this paper.